We present a magnetic tunnel junction (MTJ) where its two ferromagnetic layers are in the form of a single ellipse (SE) and two-crossing ellipses (TCE). The MTJ exhibits four distinct resistance states corresponding to the four remanent magnetic configurations which give rise to four resistance states. The MTJ is on top of a Ta cross which allows its switching by SOTs induced by flowing current in the underlying Ta layer. As the method presented here for increasing the number of resistance states of a MTJ can be extrapolated for achieving a much larger number of resistance states, the demonstrated four-states MTJ which is switchable with SOTs is an important step towards realization of multi-level MRAM. In addition, multi-level MTJs may be important in other applications such as neural computation.

Our devices are fabricated using heterostructures of \( \beta\)-Ta(10)/Ni\(_{0.8}\)Fe\(_{0.2}\)(2)/Al\(_2\)O\(_3\)(1.2)/Ni\(_{0.8}\)Fe\(_{0.2}\)(4)/Ta(5), where the numbers in parenthesis are in nanometer. The layers are deposited on thermally oxidized Si substrate using a N3000 ion-beam sputtering deposition system (the details of the deposition is described in Ref.\(^{38,39}\)). In particular, the Al\(_2\)O\(_3\) tunnel barriers were prepared by a two-step deposition/oxidation process. First, Al(0.7 nm) is deposited and oxidized by remote plasma for 15 sec (mixture of 20 sccm oxygen and 4 sccm argon), followed by a repetition of Al(0.5 nm) deposition and 15 sec oxidation\(^{40}\).

The bottom \( \beta\)-Ta layer is patterned in the form of a cross, with a crossing area of \( 6 \times 6 \) \( \mu \)m\(^2\) by laser lithography followed by Ar-ion milling. At the crossing area, the bottom NiFe layer is patterned by electron beam lithography and Ar-ion milling in the form of TCE, with the principal axes of 1 and 8 \( \mu \)m long. A nominal resist thickness of 500 nm was used, with optimized energy and development time, to minimize backscattering effects at the crossing area, while ensuring well defined ellipses tips\(^{31}\). The bottom \( \beta\)-Ta layer is then passivated first with Al\(_2\)O\(_3\)(9 nm) using RF sputtering. Lift-off is performed to access the TCE. Then, a second e-beam lithography followed by a two-angle Ar-ion milling\(^{41}\) is used to define the Al\(_2\)O\(_3\) junction and top NiFe layers into a SE of dimension 150 nm\( \times \)900 nm in the overlap area of the TCE. The long axis of the SE makes an angle of 22.5\( ^\circ \) with one of the
FIG. 1. (a) Schematic of the MTJ, including (top left panel) the mask layout with the bottom electrode (BE) of $\beta$-Ta patterned into a crossed shape (the numbering denotes the contact pads) and the top electrode (TE), (center panel) the cross sectional view of the full MTJ stack and (bottom panel) the relative orientations of the TCE and the SE defined at 22.5°. The easy axes of TCE are denoted as $M_1$, $M_2$, $M_3$ and $M_4$. (b) Top-view optical image of the overall device, showing in the middle the TE over the TCE and SE. (c) SEM image of the MTJ area where the top SE is fabricated at the overlap area of the bottom TCE.

The principal axes of the TCE (Fig. 1). The final passivation is performed with $\text{Al}_2\text{O}_3$ (50 nm) and lift-off to open top via to the nanopillar. Top electrode is defined by laser lithography and lift-off of ion-beam deposited Ru(40 nm) and sputtered $\text{Al}_{98.5}\text{Si}_{1.5}\text{Cu}_{0.5}(300 \text{ nm})/\text{Ti}_{10}\text{W}_{90}$ (N$_2$ denotes that during the deposition of the layer the atmosphere was mostly of Nitrogen that incorporates N$_2$ in the film to render it inert and work as a better protective layer). The schematics and the scanning electron microscopy (SEM) images are shown in Fig. 1. All the measurements are done at room temperature using a home-made system consisting of a Helmholtz coil and a sample rotator with resolution of 0.03°.

As shown in previous works, a SE structure exhibits uniaxial magnetic anisotropy with the easy axis along the long axis of the ellipse, whereas TCE exhibit bi-axial magnetic anisotropy with the easy axes in between the long axes of the ellipses. As in our experiments we want the magnetization of the SE to remain fixed, it is designed so that its minimum switching field (> 100 Oe) would be much larger than the minimum switching field of the TCE (~ 5 Oe).

Fig. 2 presents magnetic characterization of our device performed by measuring planar Hall resistance ($R_{\text{PHE}}$) and the MTJ resistance ($R_{\text{MTJ}}$). $R_{\text{PHE}}$ is measured by driving a current of 100 µA along one of the arms of the Ta cross and measuring the voltage across the other Ta arm. $R_{\text{MTJ}}$ is measured with a current of 5 µA through the MTJ (see Fig 1). Fig. 2a) and (b) show $R_{\text{PHE}}$ and $R_{\text{MTJ}}$ measured after a field of 7 Oe is applied and removed at different angles $\alpha$ between current and field direction. The chosen field is sufficient to switch the TCE between its four remanent states but too small to flip the remanent magnetization of the SE. We note four different values for $R_{\text{MTJ}}$ and two different values for $R_{\text{PHE}}$. $R_{\text{MTJ}}$ depends on the relative orientation of the magnetization of the FM layers and is given by:

$$R_{\text{MTJ}}(\beta) = R_{\text{AV}} - \frac{1}{2}\Delta R \cos \beta$$  \hspace{1cm} (1)

where $\beta$ is the angle between the magnetization direction of the two layers, $R_{\text{AV}} = (R_P + R_{\text{AP}})/2$, $R_P$ and $R_{\text{AP}}$ are the resistance of the MTJ when the magnetization of the two layers is in parallel and anti-parallel states, respectively, and $\Delta R = R_{\text{AP}} - R_P$. The four states of $R_{\text{MTJ}}$ follow the above mentioned Eq. 1. The exact switching positions between the remanent states in both Fig. 2a) and (b) strongly indicate that the four $R_{\text{MTJ}}$ values correspond to the four states of the TCE. $R_{\text{PHE}}$ shows two resistance states due to the symmetry of $R_{\text{PHE}}$ un-
FIG. 2. (a) and (b) $R_{\text{PHE}}$ and $R_{\text{MTJ}}$, respectively, as a function of the angle $\alpha$ at which a field of 7 Oe is applied and removed. The presented data are taken at zero field for each field direction. The illustrations show the direction of magnetization of top SE structure (blue arrow), the bottom TCE structure (black arrow).

Under magnetization inversion. To obtain maximum separation between the states, the SE long axis is rotated 22.5° from the principal axis of the TCE (see Fig. 2(c)). The lack of precise equidistance between $R_{\text{MTJ}}$ values can be explained by slight misalignment during fabrication.

We now turn to explore switchings between the four resistance states of the MTJ. Fig. 3(a) and (b) show switchings between different remanent states by external applied fields. For every field value, the measurement is performed after switching off the field. Fig. 3(c) shows reversible switchings between two states by flowing current in the underlying horizontal Ta-strip in the absence of any external field. The current in the Ta-strip affects only the TCE structure, keeping the magnetization of the SE unaffected. The measurements are performed by flowing pulses of various amplitudes through the Ta-strip and after each pulse we measure $R_{\text{MTJ}}$ with a current of 5 µA, which does not affect the magnetization in both structures. Flowing current in the vertical strip, yields reversible switchings between the two other remanent states (Fig. 3(d)). Considering current shunting between the Ta-strip and the TCE, switching current value ($I_{\text{SW}}$) of 10 mA corresponds to current density of $\sim 1.5 \times 10^7$ A/cm² in the Ta layer. The reproducibility of the switchings between the states is demonstrated by flowing 50 pulses of 12 mA in alternating directions in the horizontal Ta-strip (see Fig. 3(e)). Table I shows the response of all initial states to all currents in a given

FIG. 3. (a) and (b) show field-induced switching between different remanent states. (c) and (d) Field-free SOT-induced switchings between two remanent states of MTJ by flowing current in horizontal and vertical Ta-strips, respectively. (e) Successive switchings between two states, shown in (a), by flowing 50 pulses of amplitude 12 mA in opposite directions in the horizontal Ta-strip. The illustrations show the direction of magnetization of top SE structure (blue arrow) and the bottom TCE structure (black arrow) and the direction of current.
The switching of the MTJ is actually the switching of the TCE structure due to current flowing in the underlying Ta layer. The switching of TCE permalloy structures on top a Ta layer (not part of a MTJ) has been previously studied.\textsuperscript{33,34} Using harmonic Hall measurements and micro-magnetic simulations, it was shown that spin-orbit torques induced by the current flowing in the Ta layer play a dominant role in the switching. Here also in all the switching geometries, the direction of the Oersted field generated by the flowing current in the Ta-strip cannot be solely responsible for the switching, which confirms the SOTs as being vital for the switchings. We note that for current driven in the horizontal Ta-strip, switching occurs when the angle of the initial magnetization in the overlap area and the direction of current (\(\gamma\)) is 45 deg, whereas for current driven in the vertical Ta-strip, switching occurs when \(\gamma\) is 135 deg. Possible reasons for the differences in the behavior can be due to both the Néel "orange-peel" coupling between the ferromagnetic layers of the MTJ\textsuperscript{35,36} and stray magnetic field created by the top SE at the overlap area of TCE, which are asymmetric relative to the two Ta strips. We note that while "orange-peel" coupling is ferromagnetic, the stray field in our configuration favors antiparallel alignment. Whereas the average stray magnetic field at the overlap area of TCE can be estimated as 2.9 Oe by using an analytical solution,\textsuperscript{37} more study is required to quantify the "orange peel" coupling strength. We note that the effect of such couplings is probably manifested also in Fig. 3(d) where the threshold current needed to switch to a more anti-parallel alignment is higher than the reversed switching. While the presence of "orange-peel" coupling and stray field do not obstruct the realization of four states in our device, we observe that the effect of both of them can be reduced and even diminished. The "orange-peel" coupling can be reduced by increasing the thickness of the insulating barrier and/or decreasing the roughness of the interfaces, whereas the magnitude of the stray field can be decreased with a synthetic antiferromagnetic pinned layer structure on the top of the SE. We note that in devices with a single ferromagnetic layer where such couplings are absent (see Ref. 35), the switching is symmetric with respect to current flow in either horizontal or vertical Ta-strip.

The method presented here for achieving four resistance states per MTJ can be extrapolated to achieve a much larger number of resistance states. As shown recently, a structure consisting of \(N\) crossing ellipses may support up to \(2^{3N}\) states,\textsuperscript{37} therefore, using in a MTJ relatively simple structures of up to \(N=5\) would increase the number of resistance states quite considerably. We note that structures of up to \(N=5\) were previously studied and that simulations indicate 70 resistance states of a MTJ consisting of layers of \(N=4\) and \(N=5\) crossing ellipses structures while considering only a small subset of accessible remanent states.\textsuperscript{38} To distinguish between the different resistance states, particularly when their number is significantly increased, it would be important to use MTJs with higher magnetoresistance. This may be achieved by using a different insulating layer (e.g. MgO) and/or different FM layers (e.g. CoFeB).

In summary, we present a MTJ that supports four remanent states which correspond to four discrete resistance values. Furthermore, we demonstrate that the MTJ can be switched repeatedly between its four states using field-free spin-orbit torques induced by flowing current in an underlying Ta layer. An efficiently switchable multi-level MTJ is attractive for high-density multi-level MRAM and other intriguing applications such as magnetic memristors\textsuperscript{39-44} and magnetic neuromorphic computing.\textsuperscript{45,46}

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The data that support the findings of this study are available from the corresponding author upon reasonable request.

References


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The achieved final states for all initial states (left column) after applying all possible current directions (top row). The denotations of the states and the current pads are shown in Fig. 1.